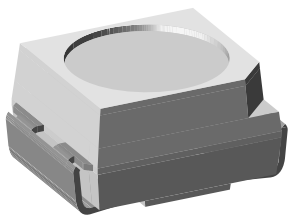
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Silicon NPN Phototransistor



FEATURES

- Package type: surface-mount
- Package form: PLCC-2
- Dimensions (L x W x H in mm): 3.5 x 2.8 x 1.75
- AEC-Q102 qualified
- Fast response times
- Suitable for visible and near infrared radiation
- Angle of half sensitivity: φ = ± 60°
- Package notch indicates collector
- Package matched with IR emitter series VSML3710
- Floor life: 168 h, MSL 3, according to J-STD-020
- Lead (Pb)-free reflow soldering
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

AUTOMOTIVE GRADE

Pb-free

e3

RoHS COMPLIANT

HALOGEN FREE

GREEN (5-2008)

DESCRIPTION

VEMT3705X02 is a high speed silicon NPN epitaxial planar phototransistor in a miniature PLCC-2 package. The device is sensitive to visible and near infrared radiation.

APPLICATIONS

- Photo interrupters
- Miniature switches
- Counters
- Encoders
- Position sensors

PRODUCT SUMMARY			
COMPONENT	I_{ca} (mA)	φ (°)	$\lambda_{0.1}$ (nm)
VEMT3705X02	0.6	± 60	480 to 1050

Note

- Test conditions see table “Basic Characteristics”

ORDERING INFORMATION			
ORDERING CODE	PACKAGING	REMARKS	PACKAGE FORM
VEMT3705X02-GS08	Tape and reel	MOQ: 7500 pcs, 1500 pcs/reel	PLCC-2
VEMT3705X02-GS18	Tape and reel	MOQ: 8000 pcs, 8000 pcs/reel	PLCC-2

Note

- MOQ: minimum order quantity

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ABSOLUTE MAXIMUM RATINGS (T_{amb} = 25 °C, unless otherwise specified)				
PARAMETER	**TEST CONDITION**	**SYMBOL**	**VALUE**	**UNIT**
Collector emitter voltage		V_{CEO}	20	V
Emitter collector voltage		V_{ECO}	7.8	V
Collector current		I_C	50	mA
Collector peak current	$t_p/T \leq 0.1$, $t_p \leq 10$ µs	I_{CM}	100	mA
Power dissipation		P_V	100	mW
Junction temperature		T_j	100	°C
Temperature range		T_{amb}	-40 to +100	°C
Storage temperature range		T_{stg}	-40 to +100	°C
Soldering temperature	According to reflow solder profile Fig. 10	T_{sd}	260	°C
Thermal resistance junction to ambient	Soldered on PCB with pad dimensions: 4 mm x 4 mm	R_{thJA}	400	K/W

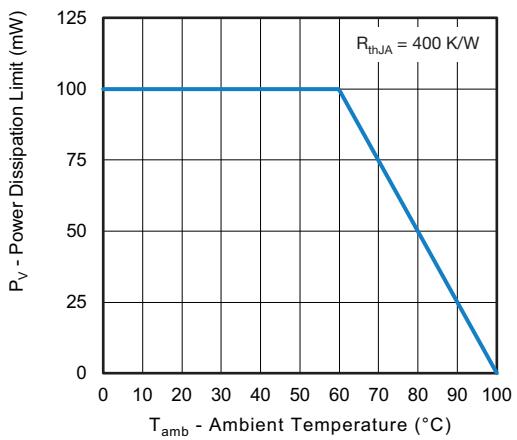


Fig. 1 - Power Dissipation Limit vs. Ambient Temperature

BASIC CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)						
PARAMETER	**TEST CONDITION**	**SYMBOL**	**MIN.**	**TYP.**	**MAX.**	**UNIT**
Collector emitter breakdown voltage	I_C = 1 mA	$V_{(BR)CEO}$	20	-	-	V
Collector emitter dark current	V_{CE} = 20 V, E = 0	I_{CEO}	-	0.2	200	nA
Collector emitter capacitance	V_{CE} = 5 V, f = 1 MHz, E = 0	C_{CEO}	-	5	-	pF
Collector light current	E_e = 1 mW/cm², λ = 940 nm, V_{CE} = 5 V	I_{ca}	0.25	0.6	-	mA
Angle of half sensitivity		φ	-	± 60	-	°
Wavelength of peak sensitivity		λ_p	-	950	-	nm
Range of spectral bandwidth		$\lambda_{0.1}$	-	480 to 1050	-	nm
Collector emitter saturation voltage	E_e = 1 mW/cm², λ = 940 nm, I_C = 0.1 mA	V_{CEsat}	-	0.11	0.3	V
Rise time	V_{CE} = 5 V, I_C = 0.7 mA, λ = 940 nm, R_L = 100 Ω	t_r	-	14	-	µs
Fall time	V_{CE} = 5 V, I_C = 0.7 mA, λ = 940 nm, R_L = 100 Ω	t_f	-	21	-	µs

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BASIC CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

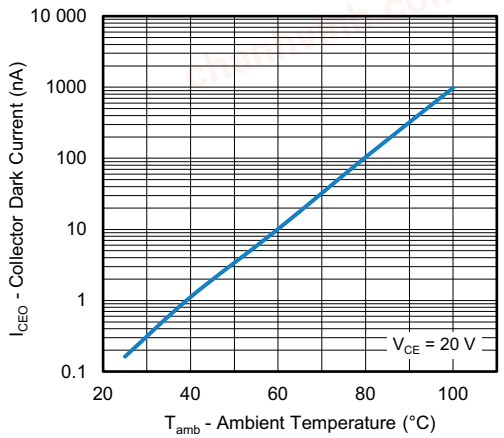


Fig. 2 - Collector Dark Current vs. Ambient Temperature

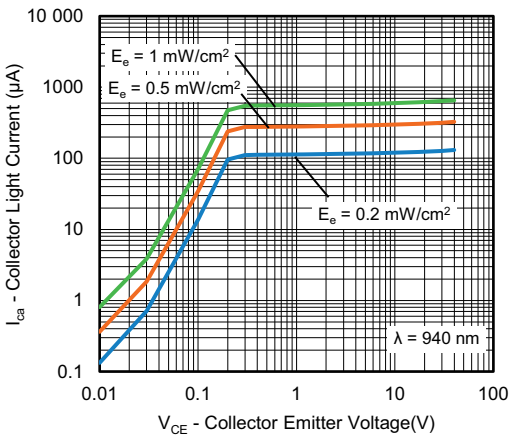


Fig. 5 - Collector Light Current vs. Collector Emitter Voltage

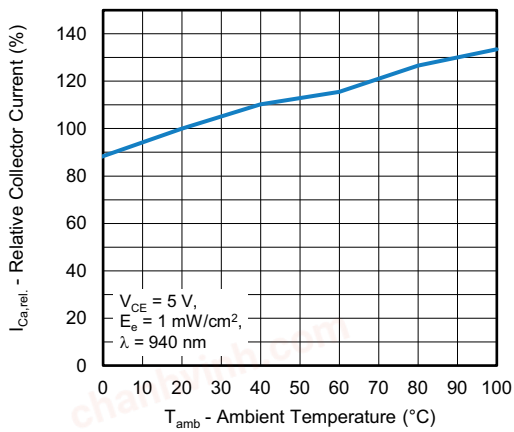


Fig. 3 - Relative Collector Current vs. Ambient Temperature

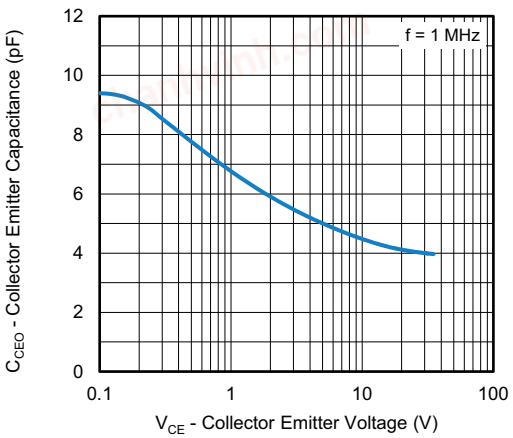


Fig. 6 - Collector Emitter Capacitance vs. Collector Emitter Voltage

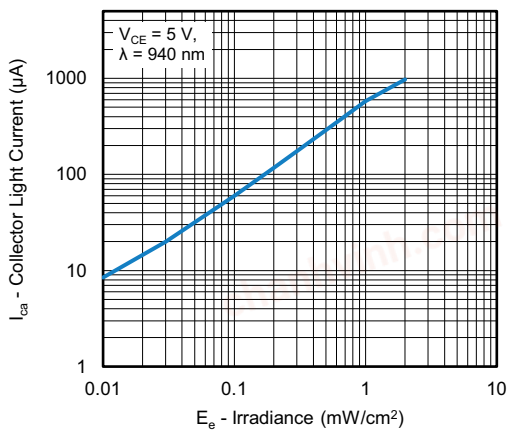


Fig. 4 - Collector Light Current vs. Irradiance

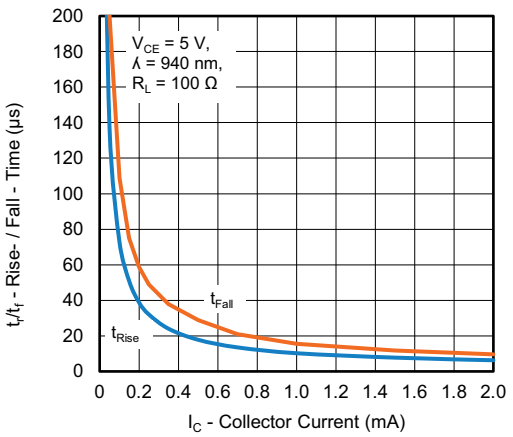


Fig. 7 - Turn-on / Turn-off Time vs. Collector Current

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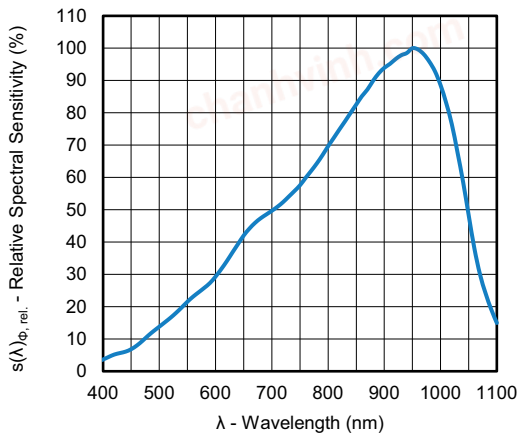


Fig. 8 - Relative Spectral Sensitivity vs. Wavelength

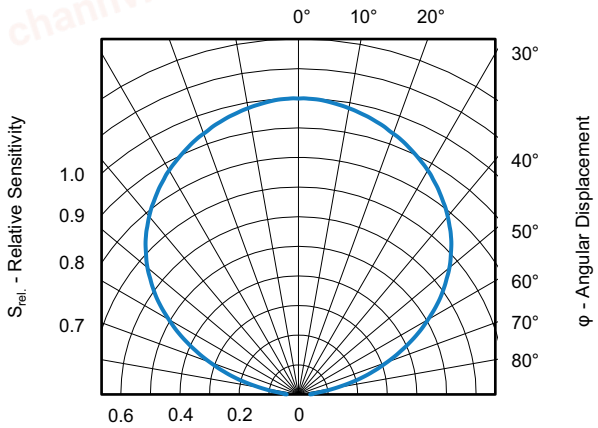
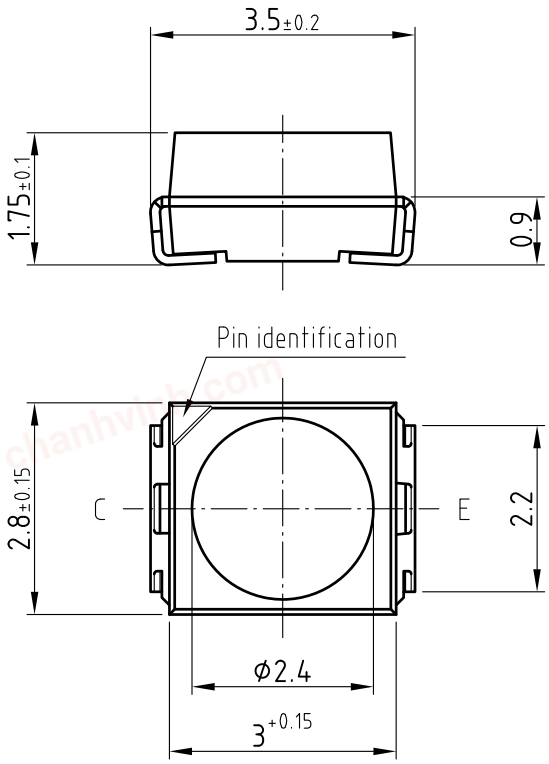
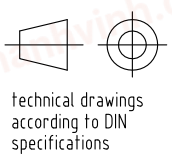


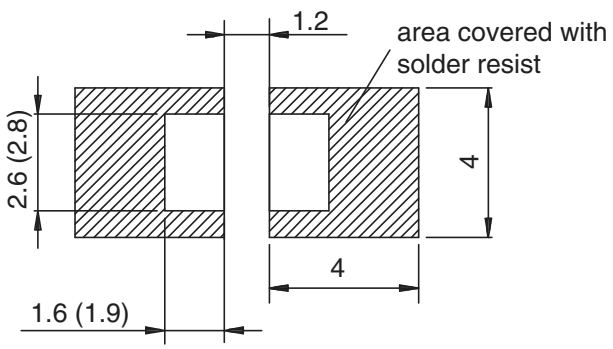
Fig. 9 - Relative Sensitivity vs. Angular Displacement

PACKAGE DIMENSIONS in millimeters





Mounting Pad Layout



Drawing-No.: 6.541-5067.03-4
Issue: 1; 30.05.07
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SOLDER PROFILE

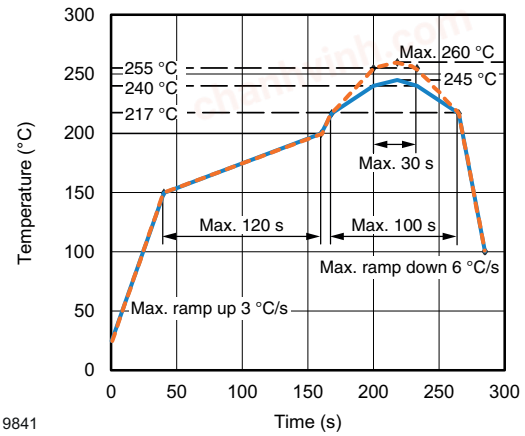


Fig. 10 - Lead (Pb)-free Reflow Solder Profile
According to J-STD-020

DRYPACK

Devices are packed in moisture barrier bags (MBB) to prevent the products from moisture absorption during transportation and storage. Each bag contains a desiccant.

FLOOR LIFE

Floor life (time between soldering and removing from MBB) must not exceed the time indicated on MBB label:

Floor life: 168 h

Conditions: T_{amb} < 30 °C, RH < 60 %

Moisture sensitivity level 3, according to J-STD-020.

DRYING

In case of moisture absorption devices should be baked before soldering. Conditions see J-STD-020 or label. Devices taped on reel dry using recommended conditions 192 h at 40 °C (+ 5 °C), RH < 5 %.

TAPE AND REEL

PLCC-2 components are packed in antistatic blister tape (DIN IEC (CO) 564) for automatic component insertion. Cavities of blister tape are covered with adhesive tape.

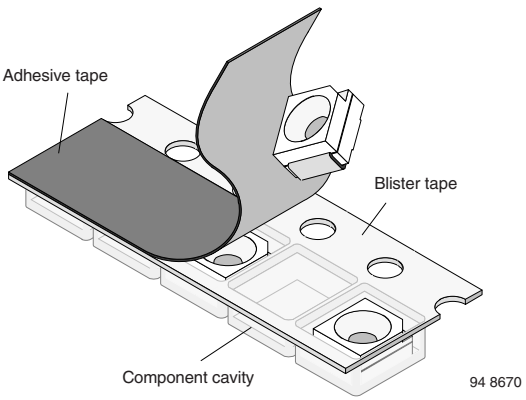


Fig. 11 - Blister Tape

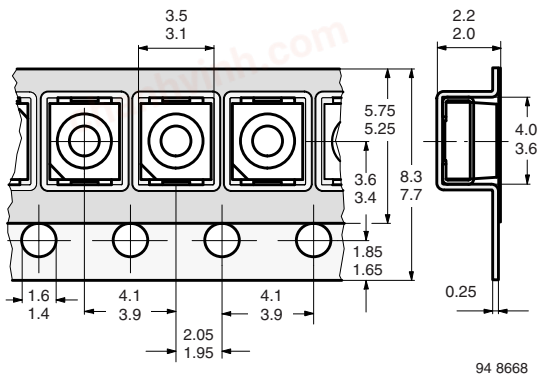


Fig. 12 - Tape Dimensions in mm for PLCC-2

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MISSING DEVICES

A maximum of 0.5 % of the total number of components per reel may be missing, exclusively missing components at the beginning and at the end of the reel. A maximum of three consecutive components may be missing, provided this gap is followed by six consecutive components.

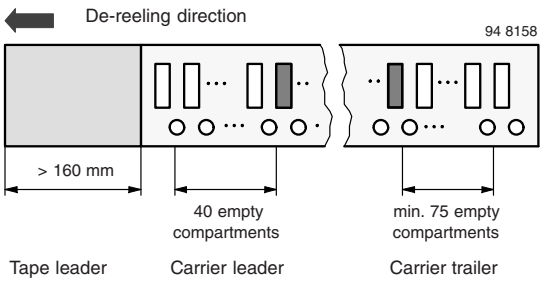


Fig. 13 - Beginning and End of Reel

The tape leader is at least 160 mm and is followed by a carrier tape leader with at least 40 empty compartments. The tape leader may include the carrier tape as long as the cover tape is not connected to the carrier tape. The least component is followed by a carrier tape trailer with a least 75 empty compartments and sealed with cover tape.

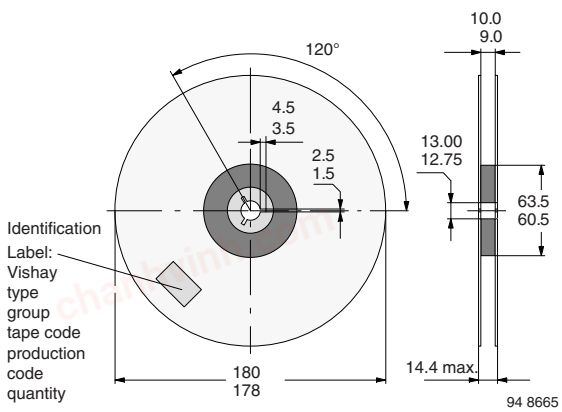


Fig. 14 - Dimensions of Reel-GS08

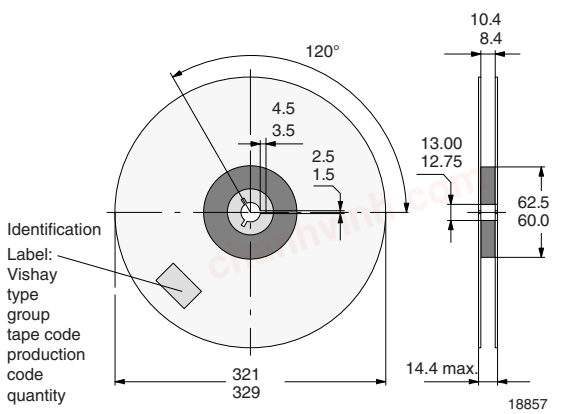


Fig. 15 - Dimensions of Reel-GS18

COVER TAPE REMOVAL FORCE

The removal force lies between 0.1 N and 1.0 N at a removal speed of 5 mm/s. In order to prevent components from popping out of the blisters, the cover tape must be pulled off at an angle of 180° with regard to the feed direction.

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